

Thermal Characteristics

$R_{\theta JC}$	Thermal Resistance, Junction to Case	30	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient (Note 1	a) 78	C/W

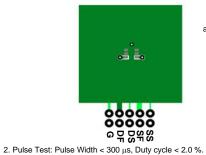
Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
.886	FDC8886	SSOT-6	7 "	8 mm	3000 units

Symbol	Parameter	Test Conditions	Min	Тур	Max	Units	
Off Chara	acteristics						
BV _{DSS}	Drain to Source Breakdown Voltage	I _D = 250 μA, V _{GS} = 0 V	30			V	
$\frac{\Delta BV_{DSS}}{\Delta T_J}$	Breakdown Voltage Temperature Coefficient	$I_D = 250 \ \mu$ A, referenced to 25 °C		18		mV/°C	
IDSS	Zero Gate Voltage Drain Current	$V_{DS} = 24 V, V_{GS} = 0 V$			1	μA	
I _{GSS}	Gate to Source Leakage Current, Forward	$V_{GS} = 20 \text{ V}, \text{ V}_{DS} = 0 \text{ V}$			100	nA	
On Chara	acteristics	· · · · · ·					
V _{GS(th)}	Gate to Source Threshold Voltage	V _{GS} = V _{DS} , I _D = 250 μA	1.2	1.9	3.0	V	
$\frac{\Delta V_{GS(th)}}{\Delta T_J}$	Gate to Source Threshold Voltage Temperature Coefficient	$I_D = 250 \ \mu$ A, referenced to 25 °C		-6		mV/°C	
r _{DS(on)}	Static Drain to Source On Resistance	V _{GS} = 10 V, I _D = 6.5 A		19	23	mΩ	
		$V_{GS} = 4.5 \text{ V}, I_D = 6.0 \text{ A}$		30	36		
		V _{GS} = 10 V, I _D = 6.5 A, T _J = 125 °C		25	30		
9 FS	Forward Transconductance	$V_{DD} = 5 \text{ V}, I_D = 6.5 \text{ A}$		24		S	
C _{iss} C _{oss} C _{rss}	Input Capacitance Output Capacitance Reverse Transfer Capacitance	V _{DS} = 15 V, V _{GS} = 0 V, f = 1 MHz		348 135 16	465 180 25	pF pF pF	
R _q	Gate Resistance			1.2	20	Ω	
Switching	g Characteristics						
t _{d(on)}	Turn-On Delay Time	-		5	10	ns	
t _r	Rise Time	$V_{DD} = 15 \text{ V}, \text{ I}_{D} = 6.5 \text{ A},$		1	10	ns	
t _{d(off)}	Turn-Off Delay Time	V_{GS} = 10 V, R_{GEN} = 6 Ω		11	19	ns	
t _f	Fall Time			1	10 7.4	ns	
-1	Tatal Cata Channe			5.3	7.4	nC	
	Total Gate Charge	$V_{GS} = 0 \text{ V to } 10 \text{ V}$		0 E	2 5		
Q _{g(TOT)}	Total Gate Charge	$V_{GS} = 0 \text{ V to } 4.5 \text{ V} \text{ V}_{DD} = 15 \text{ V}$		2.5	3.5	nC	
Q _{g(TOT)} Q _{gs}	Total Gate Charge Total Gate Charge			1.0	3.5	nC	
Q _{g(TOT)} Q _{gs} Q _{gd}	Total Gate ChargeTotal Gate ChargeGate to Drain "Miller" Charge	$V_{GS} = 0 \text{ V to } 4.5 \text{ V} \text{ V}_{DD} = 15 \text{ V}$		-	3.5	-	
Q _{g(TOT)} Q _{gs} Q _{gd} Drain-So	Total Gate Charge Total Gate Charge Gate to Drain "Miller" Charge urce Diode Characteristics	$V_{GS} = 0 \text{ V to } 4.5 \text{ V}$ $V_{DD} = 15 \text{ V}$ $I_D = 6.5 \text{ A}$		1.0 0.8		nC nC	
Q _{g(TOT)} Q _{gs} Q _{gd}	Total Gate Charge Total Gate Charge Gate to Drain "Miller" Charge urce Diode Characteristics Source to Drain Diode Forward Voltage	$V_{GS} = 0 \text{ V to } 4.5 \text{ V} \text{ V}_{DD} = 15 \text{ V}$		1.0 0.8 0.86	1.2	nC	
Q _{g(TOT)} Q _{gs} Q _{gd} Drain-So	Total Gate Charge Total Gate Charge Gate to Drain "Miller" Charge urce Diode Characteristics	$V_{GS} = 0 \text{ V to } 4.5 \text{ V}$ $V_{DD} = 15 \text{ V}$ $I_D = 6.5 \text{ A}$		1.0 0.8		nC nC	

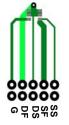
Q_{rr} NOTES:

 $R_{0,C}$ is guaranteed by design while R_{0CA} is determined by the user's board design.



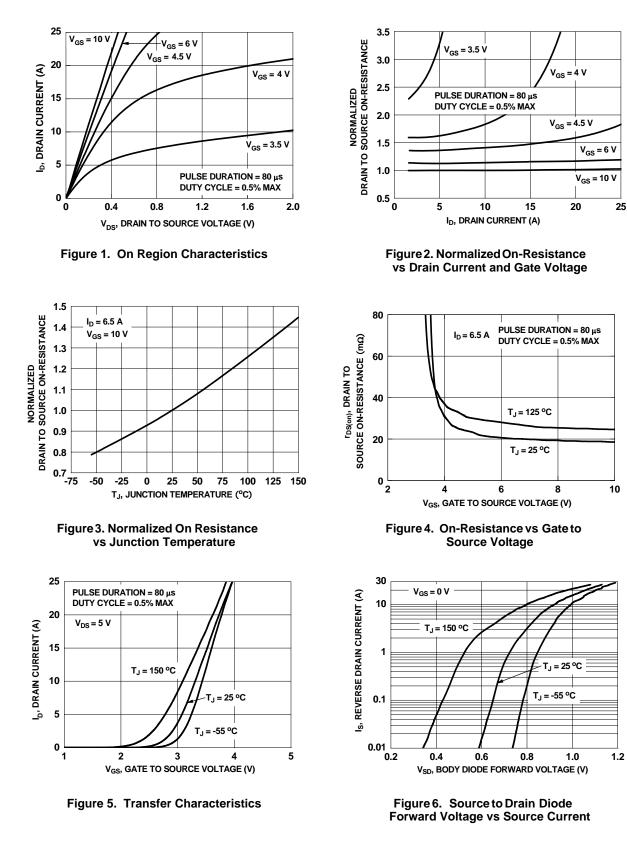
a. 78 °C/W when mounted on a 1 in² pad of 2 oz copper

3. As an N-ch device, the negative Vgs rating is for low duty cycle pulse occurrence only. No continuous rating is implied.



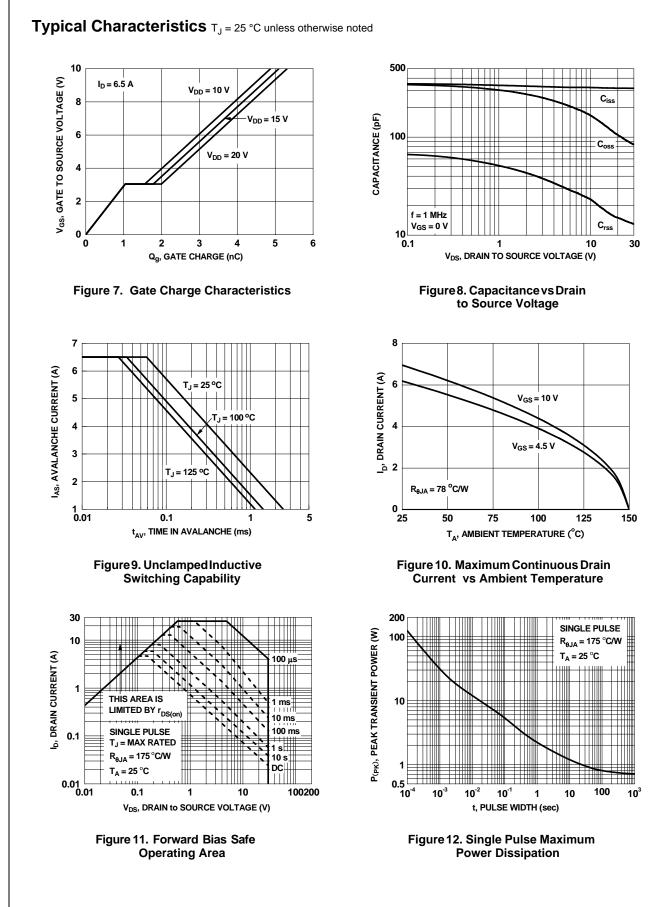
b.175 °C/W when mounted on a minimum pad of 2 oz copper

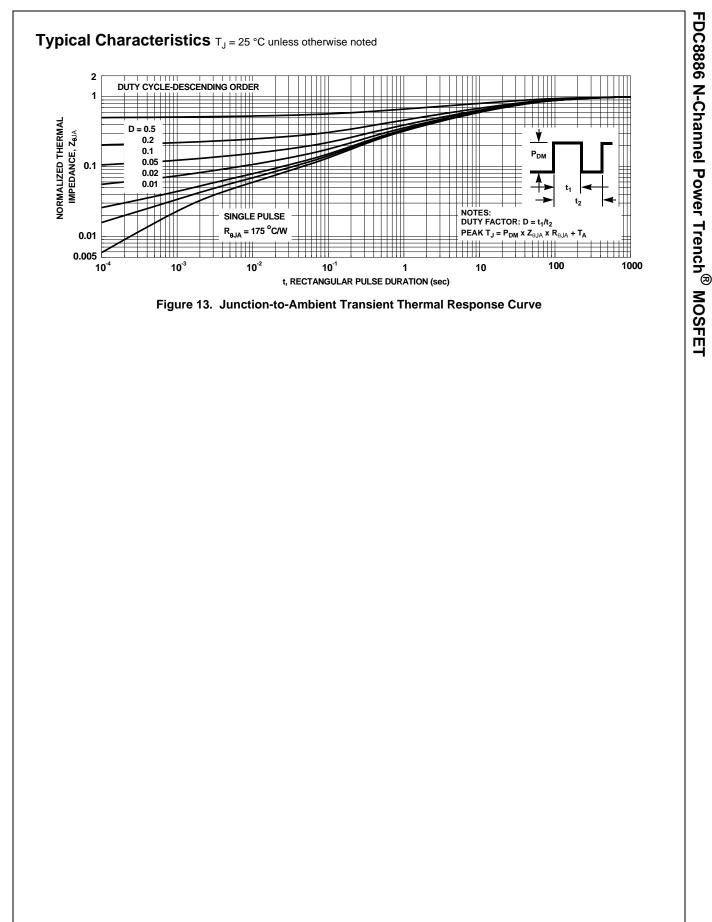
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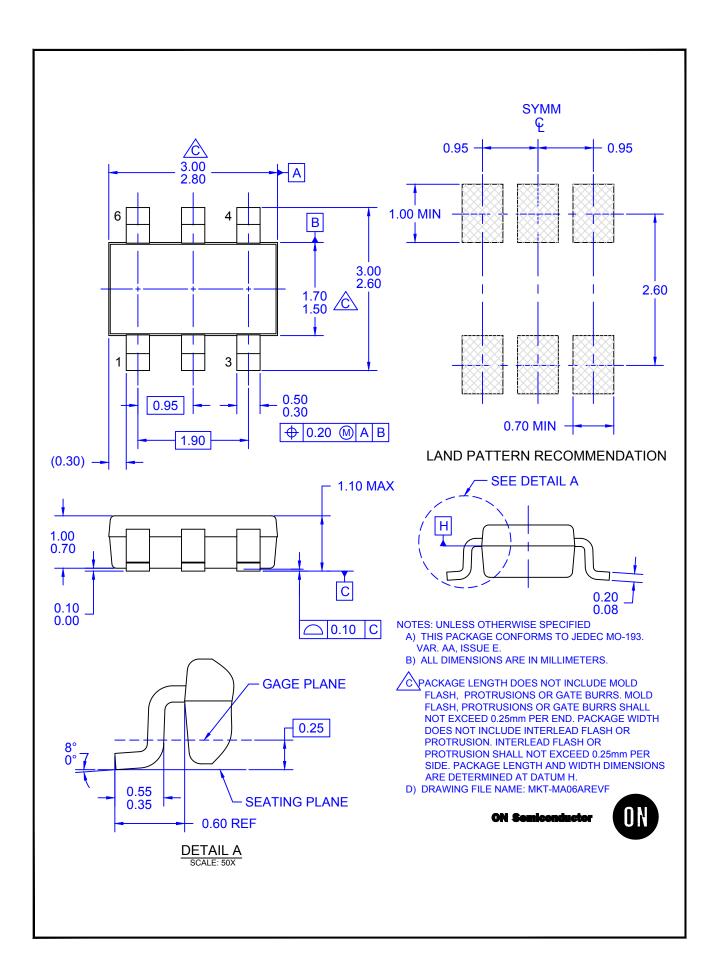


Typical Characteristics T_J = 25 °C unless otherwise noted









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